NOTES:  
A. All linear dimensions are in inches (millimeters). 
B. This drawing is subject to change without notice. 
C. This package can be hermetically sealed with a ceramic lid using glass frit. 
D. Index point is provided on cap for terminal identification. 
E. Falls within MIL STD 1835 GDIP1-T8
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Mailing Address:
Texas Instruments
Post Office Box 655303
Dallas, Texas 75265

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